

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

David R. Hembree

**Serial No.:** 10/624,332

**Filed:** July 22, 2003

**For:** CHIP ON BOARD AND HEAT SINK  
ATTACHMENT METHODS

**Confirmation No.:** 6977

**Examiner:** C. Lee

**Group Art Unit:** 2812

**Attorney Docket No.:** 2269-3592.8US  
(97-0321.08/US)

**VIA ELECTRONIC FILING**  
**June 26, 2007**

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES  
RELATING TO MAINTENANCE FEES**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

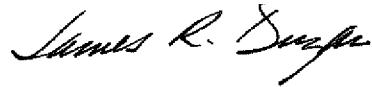
1. This letter is to specify that the FEE ADDRESSEE for this patent is:

MICRON TECHNOLOGY, INC.  
Mail Stop 525  
8000 South Federal Way  
Boise, Idaho 83707-0006

2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.

4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



James R. Duzan  
Registration No. 28,393  
Attorney for Applicant  
TRASKBRITT  
P.O. Box 2550  
Salt Lake City, Utah 84110-2550  
Telephone: 801-532-1922

Date: June 26, 2007  
JRD/dlm:lmh

Document in ProLaw